

### General Description

These P-Channel enhancement mode power field effect transistors use advanced trench technology and design to provide excellent RDS(ON) . This device is suitable for use as a load switch or in PWM applications.

### Features

- Low On-Resistance
- 100% avalanche tested
- RoHS Compliant

### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-60	V
$V_{GS}$	Gate-Source Voltage	±20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	-80	A
$I_D@T_C=100^\circ C$	Continuous Drain Current	-56	A
$I_{DM}$	Pulsed Drain Current	-320	A
EAS	Single Pulse Avalanche Energy <sup>1</sup>	264	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	135	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	50	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-case	---	0.93	°C/W

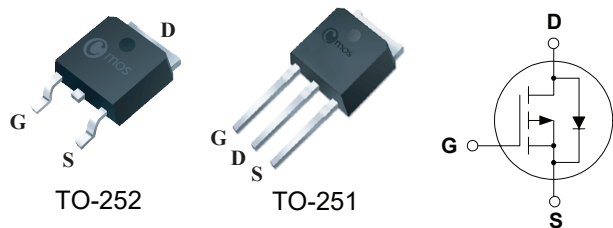
### Product Summary

BVDSS	R <sub>DS(on)</sub> max.	ID
-60V	15mΩ	-80A

### Applications

- DC-DC Converters
- Load Switches
- BLDC Motor driver

### TO-252 / 251 Pin Configuration



Type	Package	Marking
CMD80P06A	TO-252	CMD80P06A
CMU80P06A	TO-251	CMU80P06A

### Electrical Characteristics (T<sub>J</sub>=25°C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-60	---	---	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =-10V , I <sub>D</sub> =-28A	---	13	15	mΩ
		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-20A	---	16	20	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA	-1.0	---	-3.0	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V , T <sub>J</sub> =25°C	---	---	-1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = ±20V , V <sub>DS</sub> =0V	---	---	±100	nA
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =-10V , I <sub>D</sub> =-20A	---	24	---	S
R <sub>g</sub>	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz	---	46	---	Ω
Q <sub>g</sub>	Total Gate Charge	V <sub>DD</sub> =-30V , I <sub>D</sub> =-50A V <sub>GS</sub> =-10V	---	110	---	nC
Q <sub>gs</sub>	Gate-Source Charge		---	20	---	
Q <sub>gd</sub>	Gate-Drain Charge		---	28	---	
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =-30V, V <sub>GS</sub> =-10V , R <sub>L</sub> =0.6Ω R <sub>G</sub> =6Ω , I <sub>D</sub> =-50A	---	15	---	ns
T <sub>r</sub>	Rise Time		---	70	---	
T <sub>d(off)</sub>	Turn-Off Delay Time		---	175	---	
T <sub>f</sub>	Fall Time		---	175	---	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-25V, V <sub>GS</sub> =0V , f=1MHz	---	5800	---	pF
C <sub>oss</sub>	Output Capacitance		---	290	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	240	---	

### Diode Characteristics

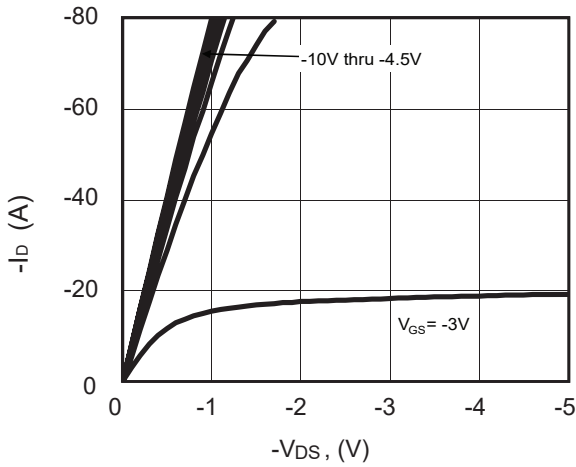
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>S</sub>	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current	---	---	-80	A
I <sub>SM</sub>	Pulsed Source Current		---	---	-320	A
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>F</sub> =-28A	---	-0.89	-1.5	V

Note :

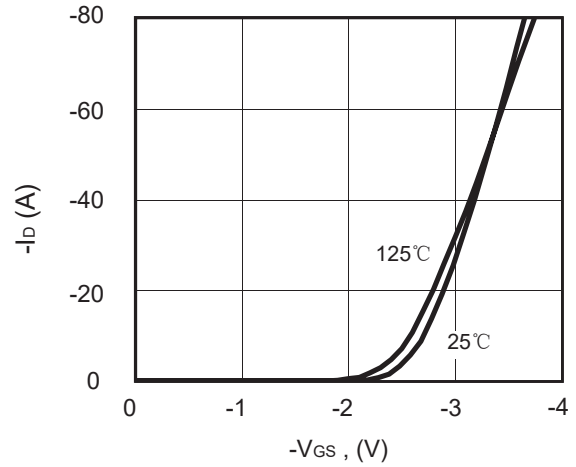
1.The EAS data shows Max. rating . The test condition is V<sub>DD</sub>=-30V , V<sub>GS</sub>=-10V , L=0.5mH , I<sub>AS</sub>=-32.5A.

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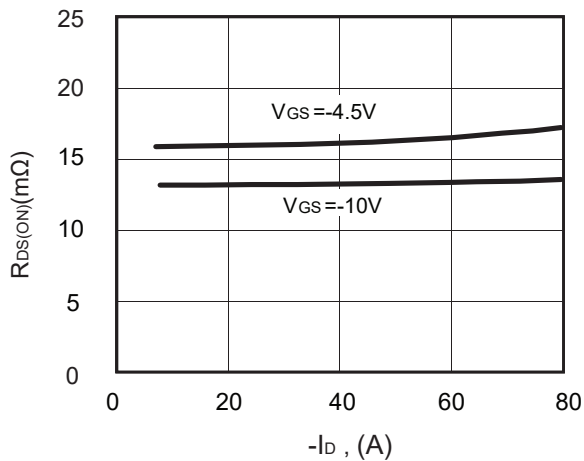
Typical Characteristics



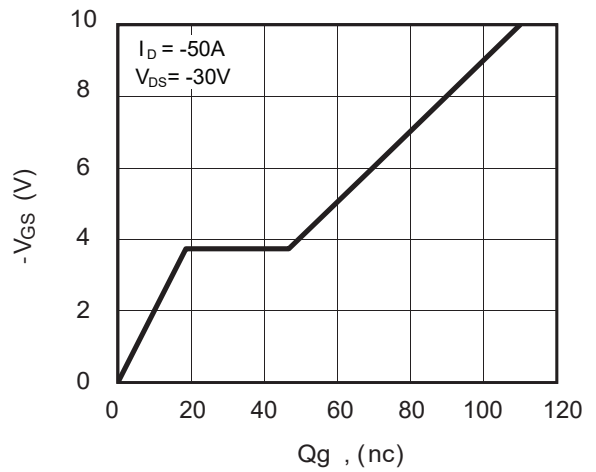
On-Region Characteristics



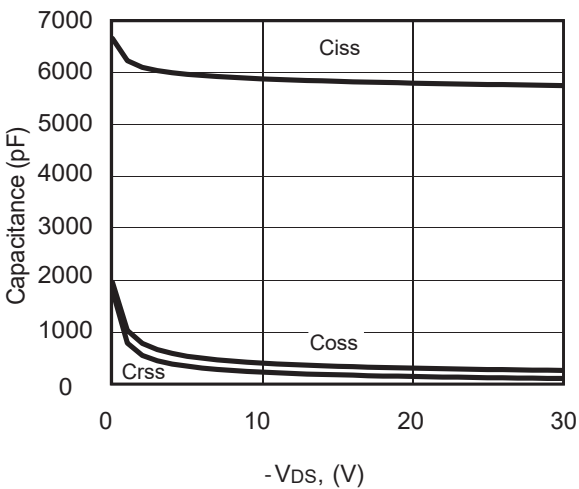
transfer characteristics



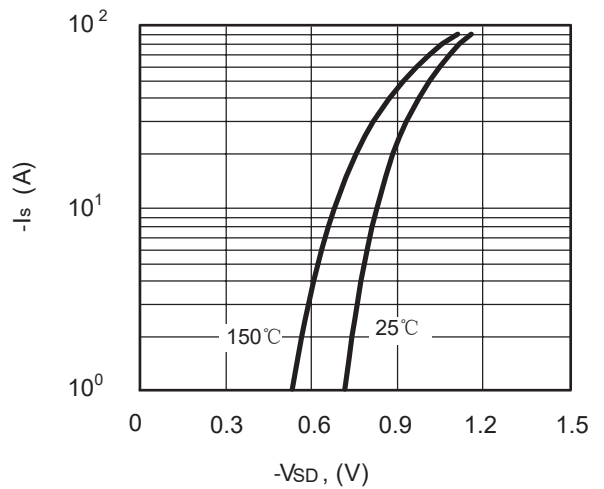
On-Resistance vs. Drain Current



Gate Charge Characteristics



Capacitance Characteristics



Body Diode Forward Voltage Variation with Source Current and Temperature